



# Xeva-1.7-320

# Cooled and stable Xeva-1.7-320 for excellent image quality research

In one compact housing, the Xeva-1.7-320 digital camera combines a thermo-electrically cooled InGaAs detector head and the control and communication electronics.

The Xeva-1.7-320 unit is available with standard (up to 1.7 μm) InGaAs detector arrays and comes in various speed versions: 60 Hz, 100 Hz and 350 Hz. It allows you to choose the most suitable detector-camera configuration for your specific application.

The camera head interfaces to a PC via standard USB 2.0 or CameraLink.

Each camera is delivered with a graphical user interface Xeneth, which offers direct access to various camera settings such as exposure time and operating temperature. The software tools include two-point non-uniformity correction and bad pixel replacement.

### **Designed for use in**











⊪ R&D SWIR

- R&D (SWIR range)
- · Hyperspectral imaging
- Semiconductor inspection
- High temperature thermography (300°C to 1200°C range or up to 2000°C)

### Benefits & Features

- Spectrometer compatible
- · Thermal imaging of hot objects
- High sensitivity for low-light conditions
- Extending SWIR imaging to the visible
- Cooled operation for low light-level imaging
- Flexible programming in an open architecture
- · CameraLink and triggering for high speed imaging

## **▶ Specifications**

Array specifications	Xeva-1.7-320			
Array Type	InGaAs			
Spectral band	Standard: 0.9 to 1.7 µm Optional: 0.4 to 1.7 µm*			
# Pixels	320 x 256			
Pixel Pitch	30 μm			
Array Cooling	TE1-cooled down to 263K Optional TE3-cooled down to 223K**			
Pixel operability	> 99%			

For more product information you can consult the Xeva-1.7-320 VISNIK prochure

For more product information you can consult the Xeva-1.7-320 TE3 brochure

Camera specifications	60 Hz	100 Hz	350 Hz		
Focal length	Visible lens 16mm f/	1.4			
Optical interface	C-Mount, spectrograph fixation holes (Broad selection of lenses are available)				
Frame rate	60 Hz	100 Hz	350 Hz		
Integration type	Snapshot				
Exposure time range	1 μs up to 100 seconds (TE3; Low gain)				
Noise level: Low gain High gain	6 AD counts on 14 bit 15 AD counts on 14 bit				
S/N ratio: Low gain High gain	68 dB 60 dB				
A to D conversion resolution	12 bit or 14 bit				
Camera control	USB 2.0				
Image acquisition	USB 2.0 / CameraLin	k			
Trigger	TTL levels				
Graphical User Interface (GUI)	Xeneth Advanced				
Power consumption	< 4 Watt, cooler: 30 Watt max				
Input voltage	12 V				
Camera cooling	Forced convection co	ooling			
Ambient operating temperature	0 to 50 °C				
Dimensions	90 W x 110 H x 110 l	_ mm³			
Weight camera head	App. 1.8 kg				
Weight power supply	300 g				

## **▶ Product selector guide**

Part numl	oer	Digital Interface	Analog Interface	ADC	Frame rate (Hz)	Cooling
XEN-0001	00	USB 2.0	N/A			
XEN-0001	02		PAL	12 hit	100	
XEN-0001	59		NTSC	12 DII	100	
XEN-0001	58		Gated			TE1
XEN-0001	04	Camera Link			60	
XEN-0001	05		N/A	14 bit	100	
XEN-0001	07				350	

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